

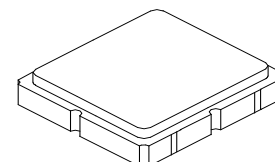
- *Low Insertion Loss SAW Filter*
- *Balanced 200 ohm Input, Single-ended 50 ohm Output*
- *Complies with Directive 2002/95/EC (RoHS)*
- *Moisture Sensitivity Level: 1*

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	+20	dBm
DC Voltage	±10	V
Operating Temperature Range	-20 to +70	°C
Storage Temperature Range in Tape and Reel	-30 to +85	°C

RF3702D

**426.44 MHz
SAW Filter**



SM3838-8

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C			426.44		MHz
3 dB Bandwidth	BW_3		1.0			MHz
Maximum Insertion Loss, 426.22 to 426.66 MHz	IL_{MAX}			2.0	3.0	dB
Amplitude Ripple, 426.22 to 426.66 MHz				0.6	1.0	dB _{P-P}
Rejection Referenced to 0 dB:						
404.64 to 405.44 MHz, [426.44 -(21 to 21.8) MHz]			50	54		dB
405.44 to 421.44 MHz			30	36		
436.44 to 447.84 MHz			20	40		
470.0 to 770.0 MHz			50	59		
800.0 to 2010.0 MHz			40	65		
Balanced Source Impedance	Z_S			200		Ω
Load Impedance	Z_L			50		Ω

Case Style	SM3838-8 3.8 x 3.8 mm Nominal Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	948, <u>YWWS</u>	
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel
	Reel Size 13 Inch	3000 Pieces/Reel

Electrical Connections

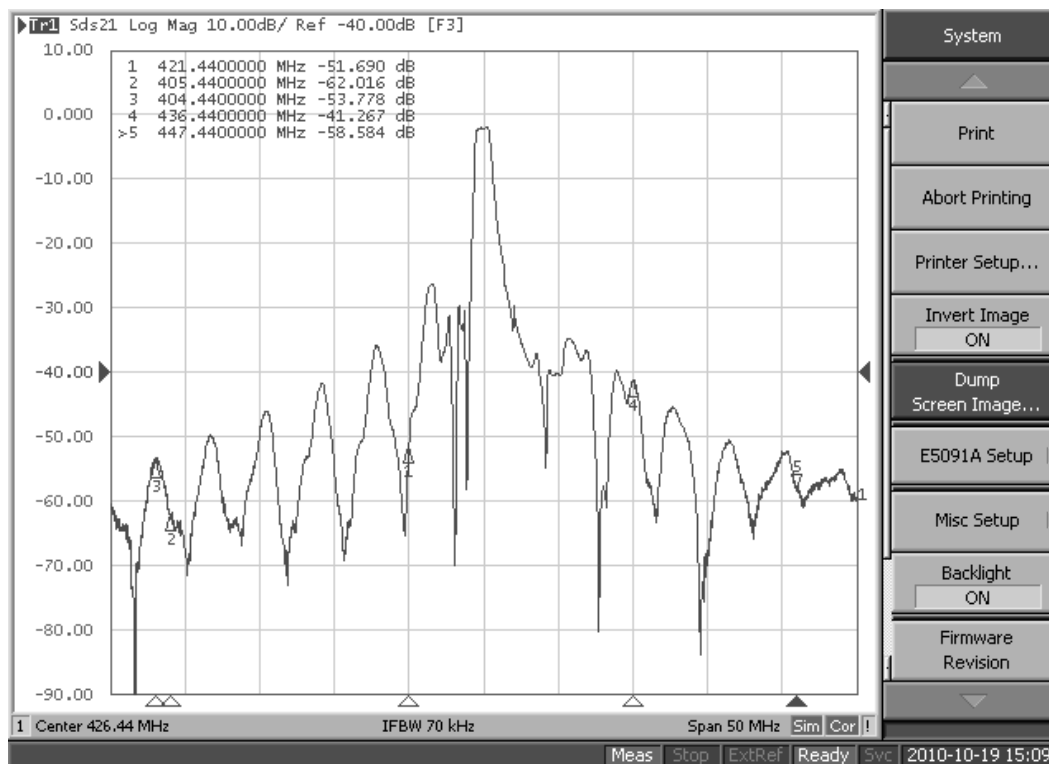
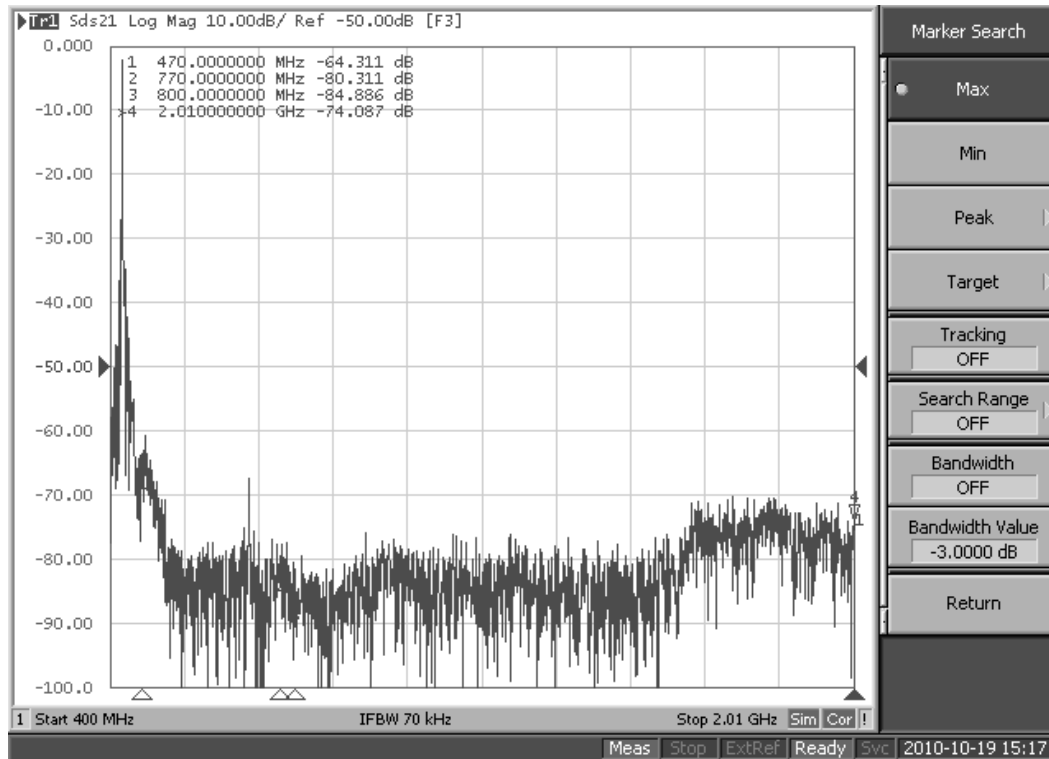
Connection	Terminals
Balanced Input	1,2
Output	5
Case Ground	3, 4, 6, 7, 8

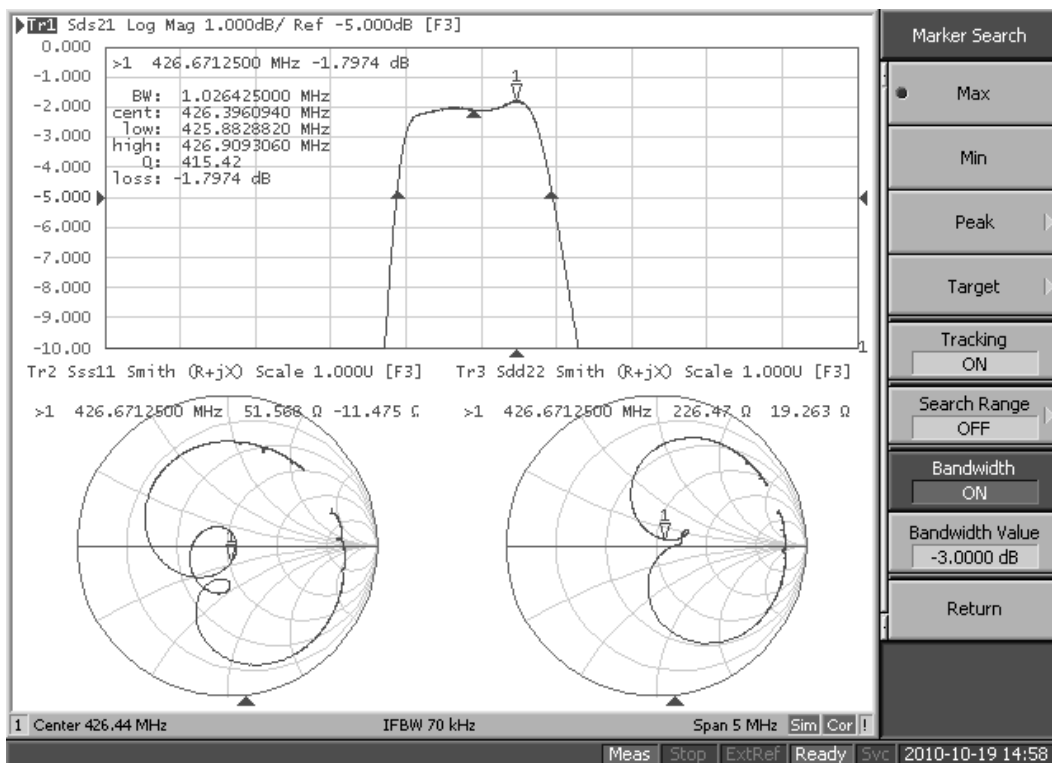
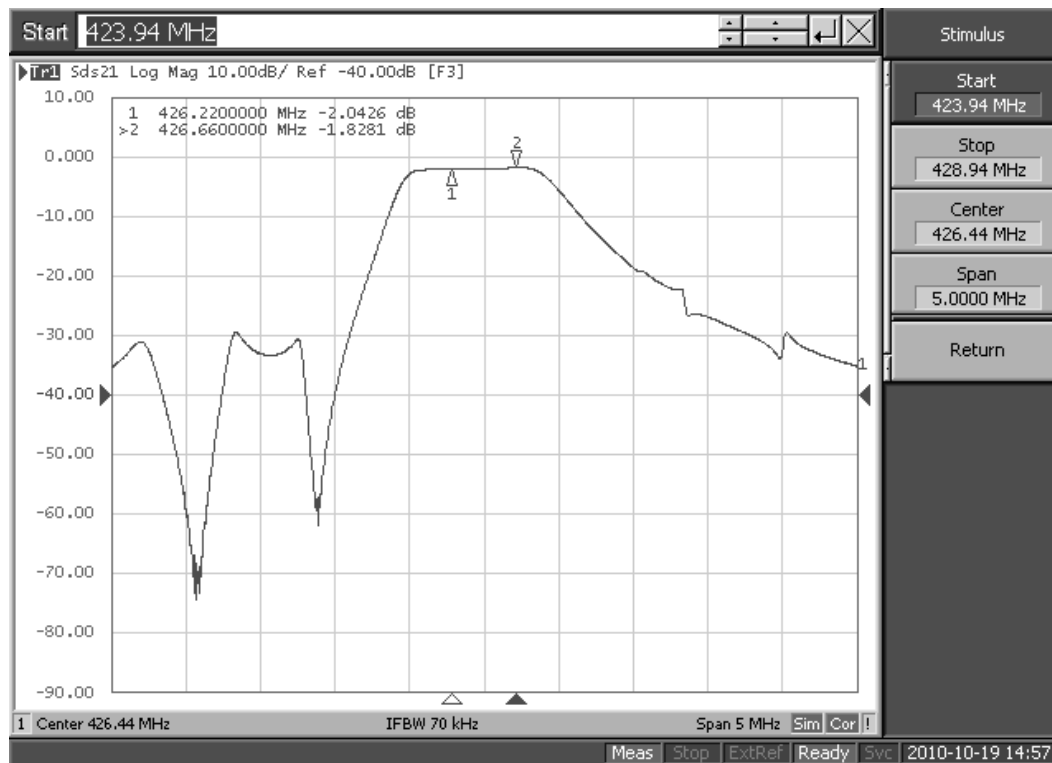
 **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

NOTES:

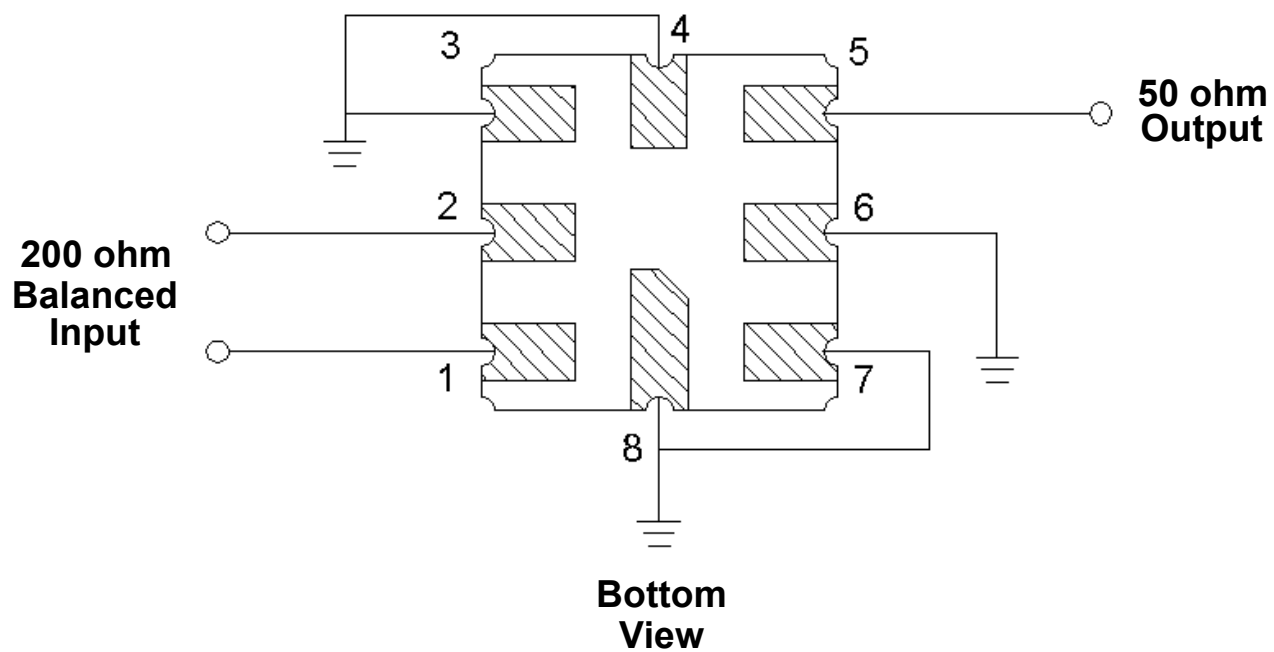
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

Frequency Response Plots



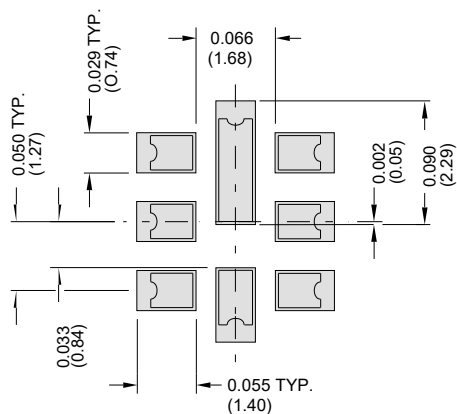


Application Circuit



SM3838-8 Case

8-Terminal Ceramic Surface-Mount Case 3.8 X 3.8 mm Nominal Footprint



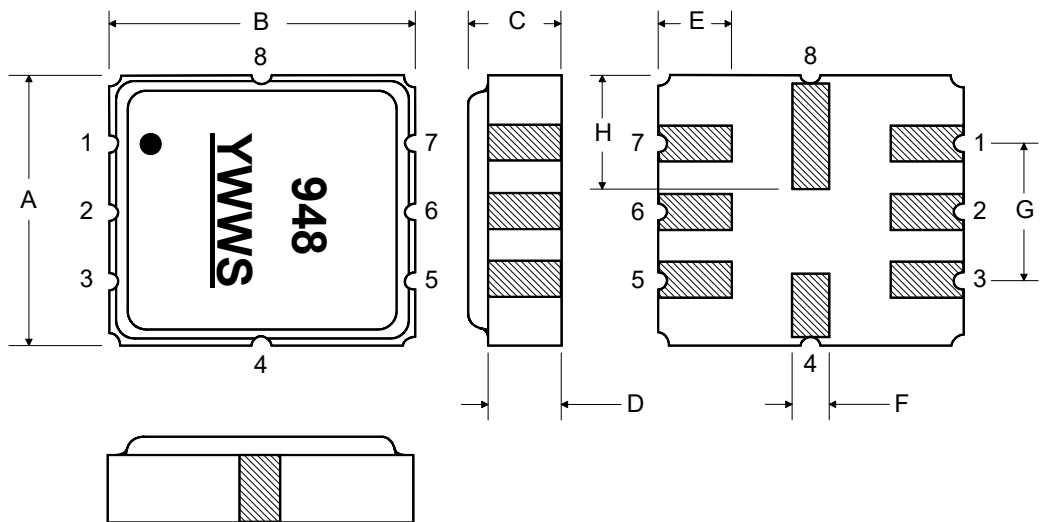
PCB Footprint

Dimension	Case Dimensions					
	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	3.6	3.8	4.0	0.142	0.150	0.157
B	3.6	3.8	4.0	0.142	0.150	0.157
C	0.90	1.00	1.1	0.035	0.040	0.043
D	0.80	0.90	1.0	0.031	0.035	0.040
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
H	1.40	1.75	2.05	0.055	0.069	0.080

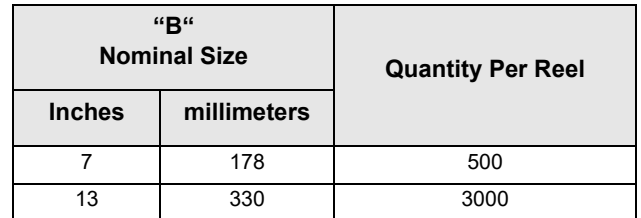
Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic

TOP VIEW

BOTTOM VIEW



Tape and Reel Standard per ANSI/EIA-481



Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.30 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

